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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Betans	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	I ² C, SPI
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	22
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 5.5V
Data Converters	A/D 5x8b
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c72a-04-so

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Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

2.2.2.2 OPTION_REG REGISTER

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The OPTION_REG register is a readable and writable register, which contains various control bits to configure the TMR0 prescaler/WDT postscaler (single assignable register known as the prescaler), the External INT Interrupt, TMR0 and the weak pull-ups on PORTB.

Note: To achieve a 1:1 prescaler assignment for the TMR0 register, assign the prescaler to the Watchdog Timer.

REGISTER 2-2: OPTION_REG REGISTER (ADDRESS 81h)

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	
RBPU	INTEDG	TOCS	T0SE	PSA	PS2	PS1	PS0	R = Readable bit
bit7							bit0	W = Writable bit
								- n = Value at POR reset
bit 7:	RBPU: PC							
		B pull-ups a				_		
	0 = PORTI	B pull-ups a	are enat	oled for all	PORTB inp	outs		
bit 6:	INTEDG: I	nterrupt Ed	lge Sele	ct bit				
	1 = Interru	pt on rising	edge o	f RB0/INT	pin			
	0 = Interru	pt on falling	g edge o	f RB0/INT	- pin			
bit 5:	TOCS: TM	R0 Clock S	ource S	elect bit				
	1 = Transit	ion on RA4	/T0CKI	pin				
		al instruction		•	(OUT)			
bit 4:	TOSE: TMI		-	•	,			
Dit 4.					on RA4/T0	CKI nin		
		•			on RA4/T0	•		
hit 0.			•			o p		
bit 3:	PSA: Pres	•						
		tler is assig tler is assig			modulo			
		0			module			
bit 2-0:	PS2:PS0:	Prescaler F	Rate Sel	ect bits				
	Bit Value	TMR0 Rat	e WD	Γ Rate				
	000	1:2	1:	1				
	001	1:4	1 :					
	010	1:8	1:					
	011	1:16	1:	-				
	100	1:32		16				
	101	1:64		32 64				
	110	1:128		64 128				
	111	1:256		120				

2.2.2.3 INTCON REGISTER

The INTCON Register is a readable and writable register, which contains various interrupt enable and flag bits for the TMR0 register overflow, RB Port change and External RB0/INT pin interrupts. Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 2-3: INTCON REGISTER (ADDRESS 0Bh, 8Bh)

R/W-0 GIE	R/W-0 PEIE	R/W-0 T0IE	R/W-0 INTE	R/W-0 RBIE	R/W-0 T0IF	R/W-0	R/W-x RBIF	R = Readable bit	
bit7	PEIE	TUIE	INTE	RBIE	TUIF	INTE	BIF bit0	R = Readable bit W = Writable bit - n = Value at POR reset	
bit 7:	GIE: Global Interrupt Enable bit 1 = Enables all un-masked interrupts 0 = Disables all interrupts								
bit 6:	 PEIE: Peripheral Interrupt Enable bit 1 = Enables all un-masked peripheral interrupts 0 = Disables all peripheral interrupts 								
bit 5:	TolE : TMR0 Overflow Interrupt Enable bit 1 = Enables the TMR0 interrupt 0 = Disables the TMR0 interrupt								
bit 4:	IINTE: RB0/INT External Interrupt Enable bit 1 = Enables the RB0/INT external interrupt 0 = Disables the RB0/INT external interrupt								
bit 3:	RBIE : RB Port Change Interrupt Enable bit 1 = Enables the RB port change interrupt 0 = Disables the RB port change interrupt								
bit 2:	T0IF : TMR0 Overflow Interrupt Flag bit 1 = TMR0 register has overflowed (software must clear bit) 0 = TMR0 register did not overflow								
bit 1:	INTF: RB0/INT External Interrupt Flag bit 1 = The RB0/INT external interrupt occurred (software must clear bit) 0 = The RB0/INT external interrupt did not occur								
bit 0:	1 = At lea		the RB7:F	B4 input p			ite (clear by	v reading PORTB)	

6.0 TIMER2 MODULE

The Timer2 module timer has the following features:

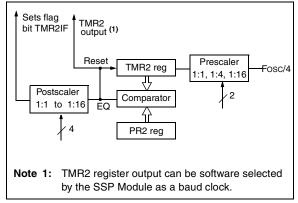
- 8-bit timer (TMR2 register)
- Readable and writable
- 8-bit period register (PR2)
 - Readable and writable
- Software programmable prescaler (1:1, 1:4, 1:16)
- Software programmable postscaler (1:1 to 1:16)
- Interrupt on match (TMR2 = PR2)
- Timer2 can be used by SSP and CCP

Timer2 has a control register, shown in Register 6-1. Timer2 can be shut off by clearing control bit TMR2ON (T2CON<2>) to minimize power consumption.

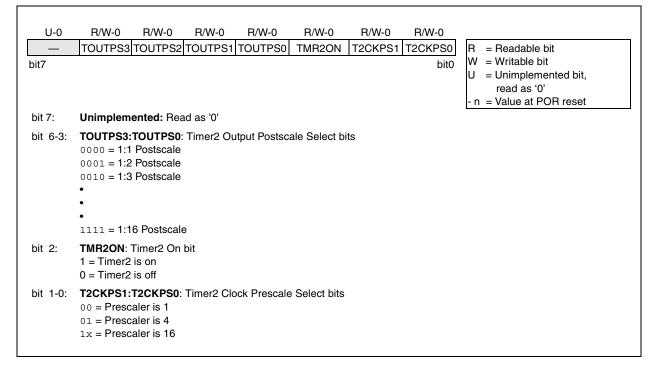
Figure 6-1 is a simplified block diagram of the Timer2 module.

Additional information on timer modules is available in the PIC[®] MCU Mid-Range Reference Manual, (DS33023).

FIGURE 6-1: TIMER2 BLOCK DIAGRAM



REGISTER 6-1:T2CON: TIMER2 CONTROL REGISTER (ADDRESS 12h)



8.3.1.3 TRANSMISSION

When the R/\overline{W} bit of the incoming address byte is set and an address match occurs, the R/\overline{W} bit of the SSPSTAT register is set. The received address is loaded into the SSPBUF register. The ACK pulse will be sent on the ninth bit and the CKP will be cleared by hardware, holding SCL low. Slave devices cause the master to wait by holding the SCL line low. The transmit data is loaded into the SSPBUF register, which in turn loads the SSPSR register. When bit CKP (SSP-CON<4>) is set, pin RC3/SCK/SCL releases SCL. When the SCL line goes high, the master may resume operating the SCL line and receiving data. The master must monitor the SCL pin prior to asserting another clock pulse. The slave devices may be holding off the master by stretching the clock. The eight data bits are shifted out on the falling edge of the SCL input. This ensures that the SDA signal is valid during the SCL high time (Figure 8-4).

An SSP interrupt is generated for each data transfer byte. Flag bit SSPIF must be cleared in software, and the SSPSTAT register used to determine the status of the byte. Flag bit SSPIF is set on the falling edge of the ninth clock pulse.

As a slave-transmitter, the \overline{ACK} pulse from the masterreceiver is latched on the rising edge of the ninth SCL input pulse. If the SDA line was high (not \overline{ACK}), then the data transfer is complete. When the \overline{ACK} is latched by the slave, the slave logic is reset (resets SSPSTAT register) and the slave then monitors for another occurrence of the START bit. If the SDA line was low (\overline{ACK}), the transmit data must be loaded into the SSPBUF register, which also loads the SSPSR register. Then pin RC3/SCK/SCL should be enabled by setting bit CKP.

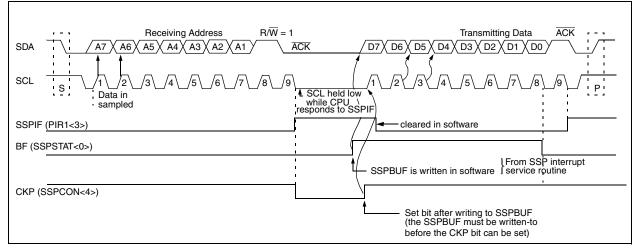


FIGURE 8-4: I²C WAVEFORMS FOR TRANSMISSION (7-BIT ADDRESS)

9.0 ANALOG-TO-DIGITAL CONVERTER (A/D) MODULE

Note: This section applies to the PIC16C72A only.

The analog-to-digital (A/D) converter module has five input channels.

The A/D allows conversion of an analog input signal to a corresponding 8-bit digital number (refer to Application Note AN546 for use of A/D Converter). The output of the sample and hold is the input into the converter, which generates the result via successive approximation. The analog reference voltage is software selectable to either the device's positive supply voltage (VDD) or the voltage level on the RA3/AN3/VREF pin.

The A/D converter has the feature of being able to operate while the device is in SLEEP mode. To operate in sleep, the A/D conversion clock must be derived from the A/D's internal RC oscillator.

Additional information on the A/D module is available in the PIC[®] MCU Mid-Range Reference Manual, (DS33023).

The A/D module has three registers. These registers are:

- A/D Result Register (ADRES)
- A/D Control Register 0 (ADCON0)
- A/D Control Register 1 (ADCON1)

A device reset forces all registers to their reset state. This forces the A/D module to be turned off, and any conversion is aborted.

The ADCON0 register, shown in Figure 9-1, controls the operation of the A/D module. The ADCON1 register, shown in Figure 9-2, configures the functions of the port pins. The port pins can be configured as analog inputs (RA3 can also be a voltage reference) or as digital I/O.

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0		
ADCS1 bit7	ADCS0	CHS2	CHS1	CHS0	GO/DONE	_	ADON bit0	R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'	
bit 7-6:	ADCS1:ADCS0: A/D Conversion Clock Select bits 00 = Fosc/2 01 = Fosc/8 10 = Fosc/32 11 = FRC (clock derived from an internal RC oscillator)								
bit 5-3:	CHS2:CHS0: Analog Channel Select bits 000 = channel 0, (RA0/AN0) 001 = channel 1, (RA1/AN1) 010 = channel 2, (RA2/AN2) 011 = channel 3, (RA3/AN3) 100 = channel 4, (RA5/AN4)								
bit 2:	GO/DON	E: A/D Co	nversion	Status bit					
	$\frac{\text{If ADON} = 1}{1 = A/D \text{ conversion in progress (setting this bit starts the A/D conversion)}$ 0 = A/D conversion not in progress (This bit is automatically cleared by hardware when the A/D conversion is complete)								
bit 1:	Unimpler	nented: F	Read as '0	ı					
bit 0:	ADON : $A_{1} = A/D c$	onverter r			l consumes no		n ourront		

REGISTER 9-1: ADCON0 REGISTER (ADDRESS 1Fh)

10.0 SPECIAL FEATURES OF THE CPU

The PIC16C62B/72A devices have a host of features intended to maximize system reliability, minimize cost through elimination of external components, provide power saving operating modes and offer code protection. These are:

- Oscillator Mode Selection
- Reset
 - Power-on Reset (POR)
 - Power-up Timer (PWRT)
 - Oscillator Start-up Timer (OST)
 - Brown-out Reset (BOR)
- Interrupts
- Watchdog Timer (WDT)
- SLEEP
- Code protection
- ID locations
- In-circuit serial programming[™] (ICSP)

These devices have a Watchdog Timer, which can be shut off only through configuration bits. It runs off its own RC oscillator for added reliability. There are two timers that offer necessary delays on power-up. One is the Oscillator Start-up Timer (OST), intended to keep the chip in reset until the crystal oscillator is stable. The

FIGURE 10-1: CONFIGURATION WORD

other is the Power-up Timer (PWRT), which provides a fixed delay on power-up only and is designed to keep the part in reset while the power supply stabilizes. With these two timers on-chip, most applications need no external reset circuitry.

SLEEP mode is designed to offer a very low current power-down mode. The user can wake-up from SLEEP through external reset, Watchdog Timer Wake-up, or through an interrupt. Several oscillator options are also made available to allow the part to fit the application. The RC oscillator option saves system cost while the LP crystal option saves power. A set of configuration bits are used to select various options.

Additional information on special features is available in the PIC[®] MCU Mid-Range Reference Manual, (DS33023).

10.1 Configuration Bits

The configuration bits can be programmed (read as '0') or left unprogrammed (read as '1') to select various device configurations. These bits are mapped in program memory location 2007h.

The user will note that address 2007h is beyond the user program memory space. In fact, it belongs to the special test/configuration memory space (2000h - 3FFFh), which can be accessed only during programming.

CP1	CP0	CP1	CP0	CP1	CP0	_	BODEN	CP1	CP0	PWRTE	WDTE	FOSC1	FOSC0	Register:	CONFIG
bit13													bit0	Address:	2007h
bit 13 5-	4:														
		00 = AII													
bit 7:	I	Jnimpl	emen	ted: R	ead as	s '1'									
bit 6:		BODEN: Brown-out Reset Enable bit ⁽¹⁾ 1 = BOR enabled 0 = BOR disabled													
bit 3:		PWRTE : Power-up Timer Enable bit ⁽¹⁾ 1 = PWRT disabled 0 = PWRT enabled													
bit 2:	:	WDTE: Watchdog Timer Enable bit 1 = WDT enabled 0 = WDT disabled													
bit 1-		FOSC1:FOSC0: Oscillator Selection bits 11 = RC oscillator 10 = HS oscillator 01 = XT oscillator 00 = LP oscillator													
Note													dless of the tion schem	e value of bit ne listed.	PWRTE.

10.8 <u>Time-out Sequence</u>

When a POR reset occurs, the PWRT delay starts (if enabled). When PWRT ends, the OST counts 1024 oscillator cycles (LP, XT, HS modes only). When OST completes, the device comes out of reset. The total time-out will vary based on oscillator configuration and the status of the PWRT. For example, in RC mode with the PWRT disabled, there will be no time-out at all.

If MCLR is kept low long enough, the time-outs will expire. Bringing MCLR high will begin execution immediately. This is useful for testing purposes or to synchronize more than one PIC16CXXX device operating in parallel.

Status Register

Table 10-5 shows the reset conditions for the STATUS, PCON and PC registers, while Table 10-6 shows the reset conditions for all the registers.

10.9 <u>Power Control/Status Register</u> (PCON)

The $\overline{\text{BOR}}$ bit is unknown on Power-on Reset. If the Brown-out Reset circuit is used, the $\overline{\text{BOR}}$ bit must be set by the user and checked on subsequent resets to see if it was cleared, indicating a Brown-out has occurred.

POR (Power-on Reset Status bit) is cleared on a Power-on Reset and unaffected otherwise. The user

IRP	RP1	RP0	TO	PD	Z	DC	С



POR BOF

TABLE 10-3 TIME-OUT IN VARIOUS SITUATIONS

Oppillator Configuration	Power	-up	Brown out	Wake-up from	
Oscillator Configuration	PWRTE = 0PWRTE = 1		Brown-out	SLEEP	
XT, HS, LP	72 ms + 1024Tosc	1024Tosc	72 ms + 1024Tosc	1024Tosc	
RC	72 ms		72 ms	—	

TABLE 10-4 STATUS BITS AND THEIR SIGNIFICANCE

POR	BOR	TO	PD	
0	x	1	1	Power-on Reset
0	x	0	x	Illegal, TO is set on POR
0	x	x	0	Illegal, PD is set on POR
1	0	1	1	Brown-out Reset
1	1	0	1	WDT Reset
1	1	0	0	WDT Wake-up
1	1	u	u	MCLR Reset during normal operation
1	1	1	0	MCLR Reset during SLEEP or interrupt wake-up from SLEEP

TABLE 10-5 RESET CONDITION FOR SPECIAL REGISTERS

Condition	Program Counter	STATUS Register	PCON Register
Power-on Reset	000h	0001 1xxx	0x
MCLR Reset during normal operation	000h	000u uuuu	uu
MCLR Reset during SLEEP	000h	0001 0uuu	uu
WDT Reset	000h	0000 luuu	uu
WDT Wake-up	PC + 1	uuu0 0uuu	uu
Brown-out Reset	000h	0001 luuu	u0
Interrupt wake-up from SLEEP	PC + 1 ⁽¹⁾	uuul 0uuu	uu

Legend: u = unchanged, x = unknown, - = unimplemented bit read as '0'.

Note 1: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

10.10 Interrupts

The interrupt control register (INTCON) records individual interrupt requests in flag bits. It also has individual and global interrupt enable bits.

Note:	Individual interrupt flag bits are set regard-
	less of the status of their corresponding
	mask bit or the GIE bit.

A global interrupt enable bit, GIE (INTCON<7>) enables or disables all interrupts. When bit GIE is enabled, and an interrupt's flag bit and mask bit are set, the interrupt will vector immediately. Individual interrupts can be disabled through their corresponding enable bits in various registers. Individual interrupt flag bits are set regardless of the status of the GIE bit. The GIE bit is cleared on reset.

The "return from interrupt" instruction, RETFIE, exits the interrupt routine and sets the GIE bit, which reenables interrupts.

The RB0/INT pin interrupt, the RB port change interrupt and the TMR0 overflow interrupt flags are contained in the INTCON register. The peripheral interrupt flags are contained in the special function registers PIR1 and PIR2. The corresponding interrupt enable bits are contained in special function registers PIE1 and PIE2, and the peripheral interrupt enable bit is contained in special function register INTCON.

When an interrupt is responded to, the GIE bit is cleared to disable any further interrupts, the return address is pushed onto the stack and the PC is loaded with 0004h. Once in the interrupt service routine, the source of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bit must be cleared in software before re-enabling interrupts to avoid recursive interrupts.

For external interrupt events, such as the INT pin or PORTB change interrupt, the interrupt latency will be three or four instruction cycles, depending on when the interrupt event occurs. The latency is the same for one or two cycle instructions. Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or the GIE bit

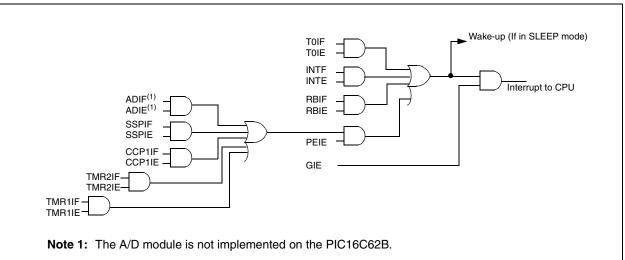


FIGURE 10-7: INTERRUPT LOGIC

COMF	Complement f
Syntax:	[label] COMF f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in [0,1] \end{array}$
Operation:	$(\overline{f}) \rightarrow (destination)$
Status Affected:	Z
Description:	The contents of register 'f' are comple- mented. If 'd' is 0, the result is stored in W. If 'd' is 1, the result is stored back in register 'f'.

GOTO	Unconditional Branch
Syntax:	[<i>label</i>] GOTO k
Operands:	$0 \le k \le 2047$
Operation:	$k \rightarrow PC<10:0>$ PCLATH<4:3> \rightarrow PC<12:11>
Status Affected:	None
Description:	GOTO is an unconditional branch. The eleven bit immediate value is loaded into PC bits <10:0>. The upper bits of PC are loaded from PCLATH<4:3>. GOTO is a two cycle instruction.

DECF	Decrement f
Syntax:	[<i>label</i>] DECF f,d
Operands:	$\begin{array}{l} 0\leq f\leq 127\\ d\in [0,1] \end{array}$
Operation:	(f) - 1 \rightarrow (destination)
Status Affected:	Z
Description:	Decrement register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.

INCF	Increment f
Syntax:	[label] INCF f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in [0,1] \end{array}$
Operation:	(f) + 1 \rightarrow (destination)
Status Affected:	Z
Description:	The contents of register 'f' are incre- mented. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'.

DECFSZ	Decrement f, Skip if 0	INCFSZ	Increment f, Skip if 0
Syntax:	[label] DECFSZ f,d	Syntax:	[label] INCFSZ f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in [0,1] \end{array}$	Operands:	$\begin{array}{l} 0\leq f\leq 127\\ d\in[0,1] \end{array}$
Operation:	(f) - 1 \rightarrow (destination); skip if result = 0	Operation:	(f) + 1 \rightarrow (destination), skip if result = 0
Status Affected:	None	Status Affected:	None
Description:	The contents of register 'f' are decre- mented. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'. If the result is 1, the next instruction, is executed. If the result is 0, then a NOP is executed instead making it a $2Tcy$ instruction.	Description:	The contents of register 'f' are incre- mented. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'. If the result is 1, the next instruction is executed. If the result is 0, a NOP is executed instead making it a $2TCY$ instruction.

PIC16C62B/72A

MPLIB is a librarian for pre-compiled code to be used with MPLINK. When a routine from a library is called from another source file, only the modules that contains that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications. MPLIB manages the creation and modification of library files.

MPLINK features include:

- MPLINK works with MPASM and MPLAB-C17 and MPLAB-C18.
- MPLINK allows all memory areas to be defined as sections to provide link-time flexibility.

MPLIB features include:

- MPLIB makes linking easier because single libraries can be included instead of many smaller files.
- MPLIB helps keep code maintainable by grouping related modules together.
- MPLIB commands allow libraries to be created and modules to be added, listed, replaced, deleted, or extracted.

12.5 MPLAB-SIM Software Simulator

The MPLAB-SIM Software Simulator allows code development in a PC host environment by simulating the PIC series microcontrollers on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a file or user-defined key press to any of the pins. The execution can be performed in single step, execute until break, or trace mode.

MPLAB-SIM fully supports symbolic debugging using MPLAB-C17 and MPLAB-C18 and MPASM. The Software Simulator offers the flexibility to develop and debug code outside of the laboratory environment making it an excellent multi-project software development tool.

12.6 <u>MPLAB-ICE High Performance</u> <u>Universal In-Circuit Emulator with</u> <u>MPLAB IDE</u>

The MPLAB-ICE Universal In-Circuit Emulator is intended to provide the product development engineer with a complete microcontroller design tool set for PIC microcontrollers (MCUs). Software control of MPLAB-ICE is provided by the MPLAB Integrated Development Environment (IDE), which allows editing, "make" and download, and source debugging from a single environment.

Interchangeable processor modules allow the system to be easily reconfigured for emulation of different processors. The universal architecture of the MPLAB-ICE allows expansion to support new PIC microcontrollers.

The MPLAB-ICE Emulator System has been designed as a real-time emulation system with advanced features that are generally found on more expensive development tools. The PC platform and Microsoft[®] Windows 3.x/95/98 environment were chosen to best make these features available to you, the end user.

MPLAB-ICE 2000 is a full-featured emulator system with enhanced trace, trigger, and data monitoring features. Both systems use the same processor modules and will operate across the full operating speed range of the PIC MCU.

12.7 PICMASTER/PICMASTER CE

The PICMASTER system from Microchip Technology is a full-featured, professional quality emulator system. This flexible in-circuit emulator provides a high-quality, universal platform for emulating Microchip 8-bit PIC microcontrollers (MCUs). PICMASTER systems are sold worldwide, with a CE compliant model available for European Union (EU) countries.

12.8 <u>ICEPIC</u>

ICEPIC is a low-cost in-circuit emulation solution for the Microchip Technology PIC16C5X, PIC16C6X, PIC16C7X, and PIC16CXXX families of 8-bit one-timeprogrammable (OTP) microcontrollers. The modular system can support different subsets of PIC16C5X or PIC16CXXX products through the use of interchangeable personality modules or daughter boards. The emulator is capable of emulating without target application circuitry being present.

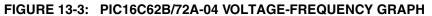
12.9 MPLAB-ICD In-Circuit Debugger

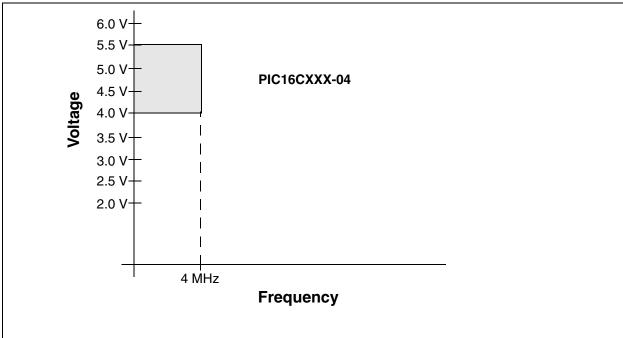
Microchip's In-Circuit Debugger, MPLAB-ICD, is a powerful, low-cost run-time development tool. This tool is based on the flash PIC16F877 and can be used to develop for this and other PIC microcontrollers from the PIC16CXXX family. MPLAB-ICD utilizes the In-Circuit Debugging capability built into the PIC16F87X. This feature, along with Microchip's In-Circuit Serial Programming protocol, offers cost-effective in-circuit flash programming and debugging from the graphical user interface of the MPLAB Integrated Development Environment. This enables a designer to develop and debug source code by watching variables, single-stepping and setting break points. Running at full speed enables testing hardware in real-time. The MPLAB-ICD is also a programmer for the flash PIC16F87X family.

12.10 PRO MATE II Universal Programmer

The PRO MATE II Universal Programmer is a full-featured programmer capable of operating in stand-alone mode as well as PC-hosted mode. PRO MATE II is CE compliant.

The PRO MATE II has programmable VDD and VPP supplies which allows it to verify programmed memory at VDD min and VDD max for maximum reliability. It has an LCD display for instructions and error messages, keys to enter commands and a modular detachable socket assembly to support various package types. In





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			Standar	d Opera	ating Co	ondition	s (unless otherwise stated)
DC CHA	RACTE	RISTICS	Operatir	ng temp	erature		\leq TA \leq +70°C for commercial
	1	1	1	1	1	-40°C	
Param No.	Sym	Characteristic	Min	Тур†	Мах	Units	Conditions
D001	Vdd	Supply Voltage	2.5	-	5.5	V	LP, XT, RC osc modes (DC - 4 MHz)
			VBOR*	-	5.5	V	BOR enabled (Note 7)
D002*	Vdr	RAM Data Retention Voltage (Note 1)	-	1.5	-	V	
D003	VPOR	VDD Start Voltage to ensure internal Power-on Reset signal	-	Vss	-	V	See section on Power-on Reset for details
D004* D004A*	SVDD	VDD Rise Rate to ensure internal Power-on Reset signal	0.05 TBD	- -	-	V/ms	PWRT enabled (PWRTE bit clear) PWRT disabled (PWRTE bit set) See section on Power-on Reset for details
D005	VBOR	Brown-out Reset voltage trip point	3.65	-	4.35	V	BODEN bit set
D010	IDD	Supply Current (Note 2, 5)	-	2.0	3.8	mA	XT, RC osc modes Fosc = 4 MHz, VDD = 3.0V (Note 4)
D010A			-	22.5	48	μA	LP OSC MODE FOSC = 32 kHz, VDD = 3.0V, WDT disabled
D020	IPD	Power-down Current	-	7.5	30	μA	VDD = 3.0V, WDT enabled, -40°C to +85°C
D021		(Note 3, 5)	-	0.9	5	μA	VDD = $3.0V$, WDT disabled, $0^{\circ}C$ to $+70^{\circ}C$
D021A			-	0.9	5	μA	VDD = 3.0V, WDT disabled, -40°C to +85°C
		Module Differential Current (Note 6)					
D022*	Δ IWDT	Watchdog Timer	-	6.0	20	μA	WDTE BIT SET, VDD = 4.0V
D022A*	Δ IBOR	Brown-out Reset	-	TBD	200	μA	BODEN bit set, VDD = 5.0V

13.2 DC Characteristics: PIC16LC62B/72A-04 (Commercial, Industrial)

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD,

 $\overline{MCLR} = VDD$; WDT enabled/disabled as specified.

- 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and VSS.
- 4: For RC osc mode, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.

5: Timer1 oscillator (when enabled) adds approximately 20 µA to the specification. This value is from characterization and is for design guidance only. This is not tested.

- 6: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.
- 7: This is the voltage where the device enters the Brown-out Reset. When BOR is enabled, the device will perform a brown-out reset when VDD falls below VBOR.

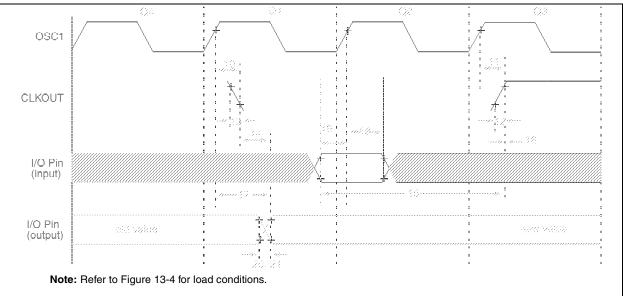
13.4 AC (Timing) Characteristics

13.4.1 TIMING PARAMETER SYMBOLOGY

The timing parameter symbols have been created following one of the following formats:

1. TppS2	ppS	3. TCC:ST	(I ² C specifications only)
2. TppS		4. Ts	(I ² C specifications only)
Т			
F	Frequency	Т	Time
Lowercas	e letters (pp) and their meanings:		
рр			
сс	CCP1	OSC	OSC1
ck	CLKOUT	rd	RD
cs	CS	rw	RD or WR
di	SDI	SC	SCK
do	SDO	SS	SS
dt	Data in	t0	TOCKI
io	I/O port	t1	T1CKI
mc	MCLR	wr	WR
Uppercas	se letters and their meanings:		
S			
F	Fall	Р	Period
Н	High	R	Rise
I	Invalid (Hi-impedance)	V	Valid
L	Low	Z	Hi-impedance
I ² C only			
AA	output access	High	High
BUF	Bus free	Low	Low
TCC:ST (I	² C specifications only)		
CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	STOP condition
STA	START condition		





Param No.	Sym	Characteristic		Min	Тур†	Мах	Units	Conditions
10*	TosH2ckL	OSC1↑ to CLKOUT↓	OSC1↑ to CLKOUT↓			200	ns	Note 1
11*	TosH2ckH	OSC1↑ to CLKOUT↑		—	75	200	ns	Note 1
12*	TckR	CLKOUT rise time		_	35	100	ns	Note 1
13*	TckF	CLKOUT fall time		_	35	100	ns	Note 1
14*	TckL2ioV	CLKOUT ↓ to Port out valid		—		0.5TCY + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLKOUT ↑		Tosc + 200		_	ns	Note 1
16*	TckH2iol	Port in hold after CLKOUT ↑		0		_	ns	Note 1
17*	TosH2ioV	OSC1 [↑] (Q1 cycle) to Port of	—	50	150	ns		
18*	TosH2iol	OSC1 [↑] (Q2 cycle) to Port	PIC16CXX	100		_	ns	
18A*		input invalid (I/O in hold time)	PIC16LCXX	200		_	ns	
19*	TioV2osH	Port input valid to OSC11 (I/O in setup time)	0	_	—	ns	
20*	TioR	Port output rise time	PIC16CXX	—	10	40	ns	
20A*			PIC16LCXX	_		80	ns	
21*	TioF	Port output fall time	PIC16CXX	—	10	40	ns	
21A*			PIC16LCXX	_	_	80	ns	
22††*	Tinp	INT pin high or low time	·	Тсү	_	—	ns	
23††*	Trbp	RB7:RB4 change INT high	or low time	Тсү	_		ns	

TABLE 13-3:	CLKOUT AND I/O TIMING REQUIREMENTS

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

tt These parameters are asynchronous events not related to any internal clock edge.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

TABLE 13-13:A/D CONVERTER CHARACTERISTICS:
PIC16C72A-04 (COMMERCIAL, INDUSTRIAL, EXTENDED)
PIC16C72A-20 (COMMERCIAL, INDUSTRIAL, EXTENDED)
PIC16LC72A-04 (COMMERCIAL, INDUSTRIAL)

Param No.	Sym	Characte	ristic	Min	Тур†	Мах	Units	Conditions
A01	NR	Resolution		—	—	8-bits	bit	$\begin{array}{l} VREF=VDD=5.12V,\\ VSS\leqVAIN\leqVREF \end{array}$
A02	Eabs	Total Absolute error	—	_	< ± 1	LSB	$\begin{array}{l} \text{VREF} = \text{VDD} = 5.12\text{V},\\ \text{VSS} \leq \text{VAIN} \leq \text{VREF} \end{array}$	
A03	EIL	Integral linearity error	_	—	< ± 1	LSB	$\begin{array}{l} \text{VREF} = \text{VDD} = 5.12\text{V},\\ \text{VSS} \leq \text{VAIN} \leq \text{VREF} \end{array}$	
A04	Edl	Differential linearity er		_	< ± 1	LSB	$\begin{array}{l} \text{VREF} = \text{VDD} = 5.12\text{V},\\ \text{VSS} \leq \text{VAIN} \leq \text{VREF} \end{array}$	
A05	Efs	Full scale error		_	< ± 1	LSB	$\begin{array}{l} \text{VREF} = \text{VDD} = 5.12\text{V},\\ \text{VSS} \leq \text{VAIN} \leq \text{VREF} \end{array}$	
A06	EOFF	Offset error	_	—	< ± 1	LSB	$\begin{array}{l} \text{VREF} = \text{VDD} = 5.12\text{V},\\ \text{VSS} \leq \text{VAIN} \leq \text{VREF} \end{array}$	
A10	—	Monotonicity	_	guaranteed (Note 3)	—		$VSS \leq VAIN \leq VREF$	
A20	VREF	Reference voltage		2.5V	—	VDD + 0.3	V	
A25	VAIN	Analog input voltage		Vss - 0.3	_	VREF + 0.3	V	
A30	ZAIN	Recommended imped analog voltage source		_	—	10.0	kΩ	
A40	IAD	A/D conversion	PIC16CXX	—	180	—	μA	Average current con-
		current (VDD)	PIC16LCXX	—	90	—	μA	sumption when A/D is on. (Note 1)
A50	IREF VREF input current (Note 2)		10		1000	μΑ μΑ	During VAIN acquisi- tion. Based on differ- ential of VHOLD to VAIN to charge CHOLD, see Section 9.1. During A/D conver-	
								sion cycle

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

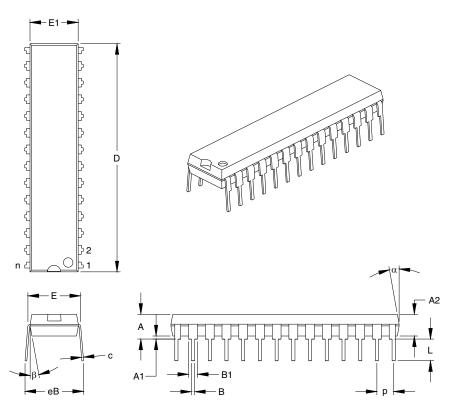
Note 1: When A/D is off, it will not consume any current other than minor leakage current.

The power-down current spec includes any such leakage from the A/D module.

2: VREF current is from RA3 pin or VDD pin, whichever is selected as reference input.

3: The A/D conversion result never decreases with an increase in the Input Voltage and has no missing codes.

28-Lead Skinny Plastic Dual In-line (SP) – 300 mil (PDIP) 15.2

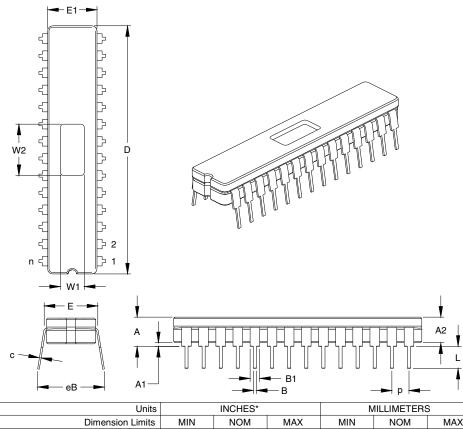


	Units				MILLIMETERS			
Dimension	Limits	MIN	NOM	MAX	MIN	NOM	MAX	
Number of Pins	n		28			28		
Pitch	р		.100			2.54		
Top to Seating Plane	Α	.140	.150	.160	3.56	3.81	4.06	
Molded Package Thickness	A2	.125	.130	.135	3.18	3.30	3.43	
Base to Seating Plane	A1	.015			0.38			
Shoulder to Shoulder Width	E	.300	.313	.325	7.62	7.94	8.26	
Molded Package Width	E1	.279	.307	.335	7.09	7.80	8.51	
Overall Length	D	1.345	1.365	1.385	34.16	34.67	35.18	
Tip to Seating Plane	L	.125	.130	.135	3.18	3.30	3.43	
Lead Thickness	С	.008	.012	.015	0.20	0.29	0.38	
Upper Lead Width	B1	.040	.053	.065	1.02	1.33	1.65	
Lower Lead Width	В	.016	.019	.022	0.41	0.48	0.56	
Overall Row Spacing	eB	.320	.350	.430	8.13	8.89	10.92	
Mold Draft Angle Top	α	5	10	15	5	10	15	
Mold Draft Angle Bottom	β	5	10	15	5	10	15	

*Controlling Parameter

Notes: Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side. JEDEC Equivalent: MO-095 Drawing No. C04-070

15.3 <u>28-Lead Ceramic Dual In-line with Window (JW) – 300 mil (CERDIP)</u>



	Units)	
Dimensio	on Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		28			28	
Pitch	р		.100			2.54	
Top to Seating Plane	Α	.170	.183	.195	4.32	4.64	4.95
Ceramic Package Height	A2	.155	.160	.165	3.94	4.06	4.19
Standoff	A1	.015	.023	.030	0.38	0.57	0.76
Shoulder to Shoulder Width	E	.300	.313	.325	7.62	7.94	8.26
Ceramic Pkg. Width	E1	.285	.290	.295	7.24	7.37	7.49
Overall Length	D	1.430	1.458	1.485	36.32	37.02	37.72
Tip to Seating Plane	L	.135	.140	.145	3.43	3.56	3.68
Lead Thickness	С	.008	.010	.012	0.20	0.25	0.30
Upper Lead Width	B1	.050	.058	.065	1.27	1.46	1.65
Lower Lead Width	В	.016	.019	.021	0.41	0.47	0.53
Overall Row Spacing	eB	.345	.385	.425	8.76	9.78	10.80
Window Width	W1	.130	.140	.150	3.30	3.56	3.81
Window Length	W2	.290	.300	.310	7.37	7.62	7.87
*0 · // D ·							

*Controlling Parameter JEDEC Equivalent: MO-058 Drawing No. C04-080

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